

• General Description

The AGM12N10A combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{\text{DS}(\text{ON})}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

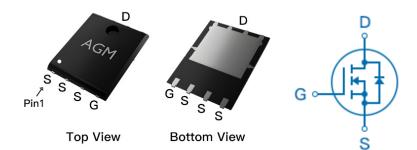
Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
100V	9.3mΩ	55A

PDFN5*6 Pin Configuration



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM12N10A	AGM12N10A	PDFN5*6	330mm	12mm	3000

Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	100	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	55	А
	Drain Current-Continuous(Tc=100℃)	35	А
IDM (pluse)	Drain Current-Pulsed (Note 2)	220	А
PD	Maximum Power Dissipation(Tc=25℃)	83	w
	Maximum Power Dissipation(Tc=100℃)	33	w
EAS	Avalanche energy (Note 3)	121	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	℃

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹		20	°C/W
RθJC	Thermal Resistance Junction-Case ¹		1.5	°C/W



Table 3. Electrical Characteristics (TJ=25℃ unless otherwise noted)

Symbol	Electrical Characteristics (1J=25 © unio Parameter	Conditions	Min	Тур	Max	Unit
On/Off Sta	ites					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250µA	100			V
IDSS	Zero Gate Voltage Drain Current	VDS=100V,VGS=0V			1.0	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	1.2	1.8	2.2	V
gFS	Forward Transconductance	VDS=5V,ID=15A		23		S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=20A		9.3	13	mΩ
1123(011)	Brain course on class reciclance	VGS=4.5V, ID=15A		13	16	mΩ
Dynamic (Characteristics					
Ciss	Input Capacitance			1080		pF
Coss	Output Capacitance	VDS=50V,VGS=0V, F=1MHZ		460		pF
Crss	Reverse Transfer Capacitance			9.0		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		11.5		Ω
Switching	Times					
td(on)	Turn-on Delay Time			16		nS
tr	Turn-on Rise Time	VGS=10V,VDS=50V,		18		nS
td(off)	Turn-Off Delay Time	ID=10A,RGEN=5Ω		32		nS
tf	Turn-Off Fall Time			10		nS
Qg	Total Gate Charge			22		nC
Qgs	Gate-Source Charge	VGS=10V, VDS=50V, ID=10A		3.7		nC
Qgd	Gate-Drain Charge	10-104		5.0		nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)				55	А
VSD	Forward on Voltage	VGS=0V,IS=20A			1.2	V
trr	Reverse Recovery Time	Is=20A ,		43		ns
Qrr	Reverse Recovery Charge	VDD=50V,dI/dt=100A/μs		90		nc

Notes 1.The maximum current rating is package limited.

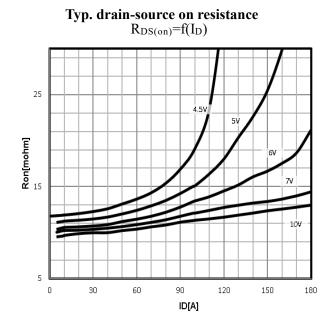
Notes 2. Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25 $^{\circ}\text{C}\,\text{,VDD}=50\text{V},\text{Vgs}=10\text{V}$, ID=22A,L=0.5mH,RG=25ohm

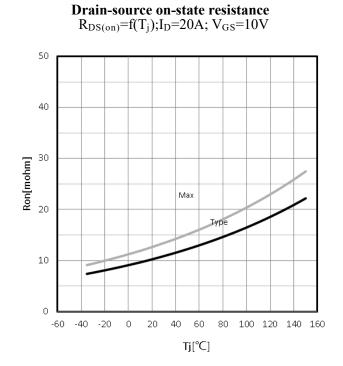


Characteristics Curve:

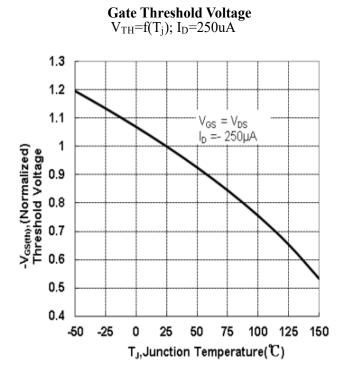
Typ. output characteristics $I_D=f(V_{DS})$



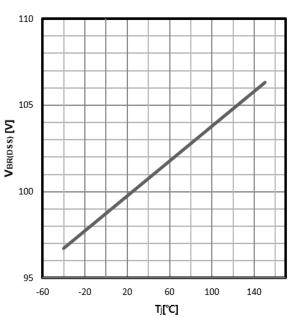
Typ. transfer characteristics $I_D = f(V_{GS})$

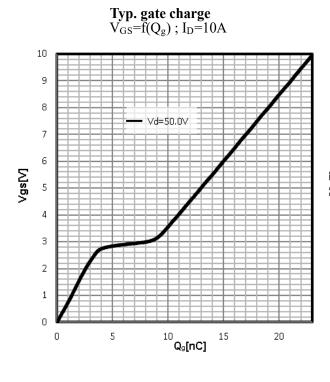


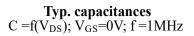


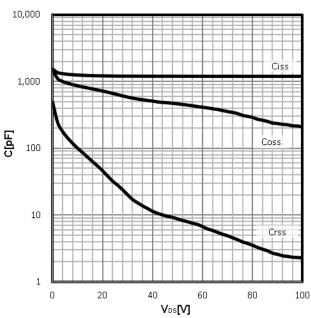


$\begin{array}{c} \textbf{Drain-source breakdown voltage} \\ V_{BR(DSS)} \!\!=\!\! f(T_j); \, I_D \!\!=\!\! 250 uA \end{array}$

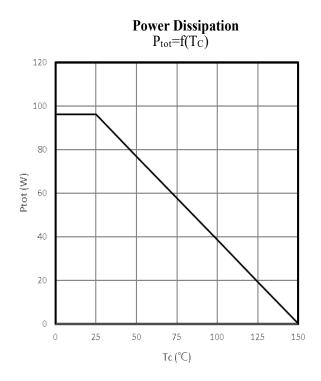


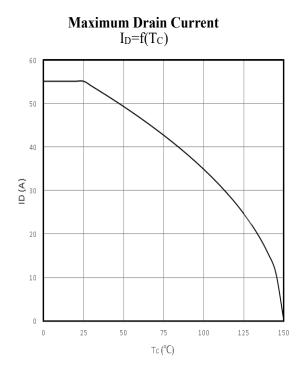


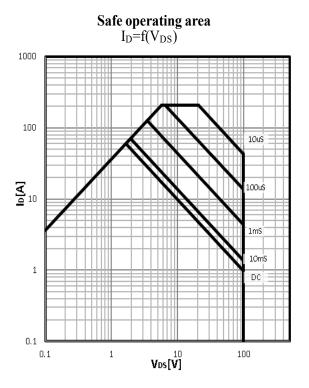


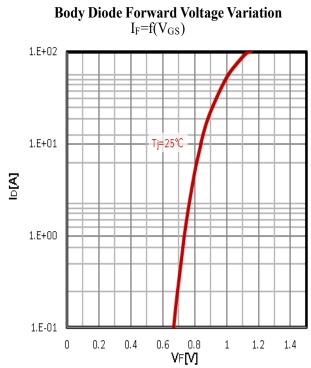






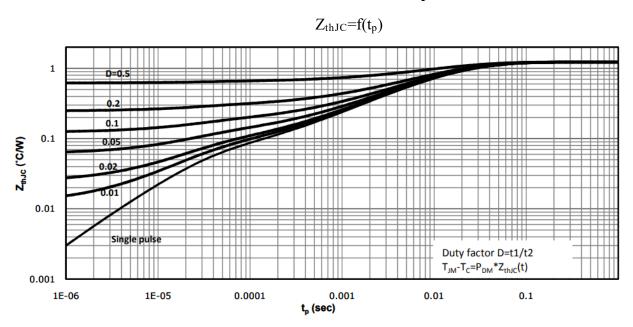






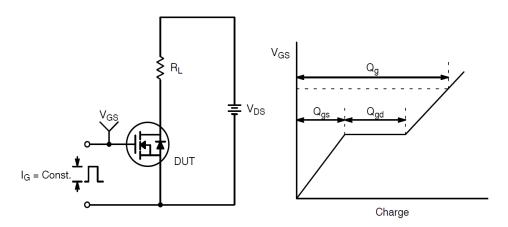


Max. transient thermal impedance

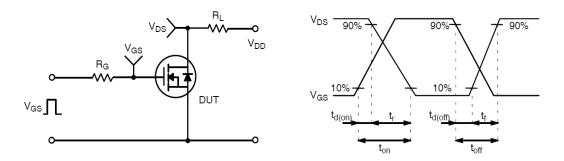




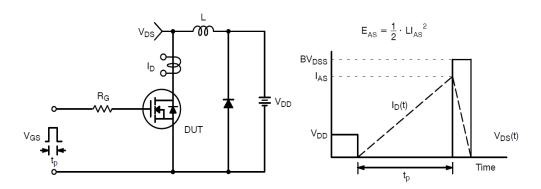
Test Circuit and Waveform:



Gate Charge Test Circuit & Waveform



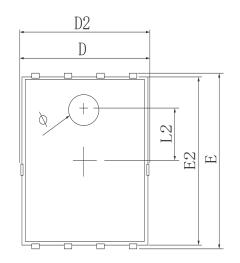
Resistive Switching Test Circuit & Waveforms

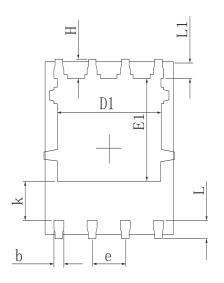


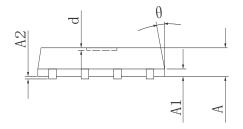
Unclamped Inductive Switching Test Circuit & Waveforms



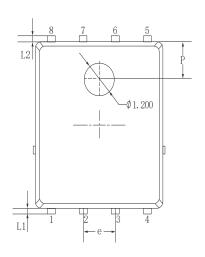
•Dimensions (PDFN5*6)

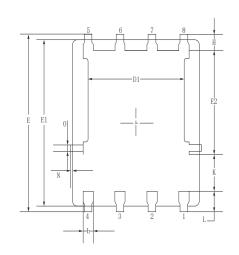






ornen or		MILLIMETER	
SYMBOL	MIN	Typ.	MAX
A	0.900	1.000	1.100
A1		0.254 REF.	
A2		0~0.05	
D	4. 824	4.900	4.976
D1	3.910	4.010	4.110
D2	4. 924	5.000	5. 076
Е	5. 924	6.000	6.076
E1	3. 375	3. 475	3. 575
E2	5. 674	5. 750	5. 826
b	0.350	0.400	0.450
е	1.270 TYP.		
L	0.534	0.610	0.686
L1	0.424	0.500	0.576
L2	1.800 REF.		
k	1.190	1.290	1.390
Н	0.549	0.625	0.701
θ	8°	10°	12°
Ф	1.100	1.200	1.300
d			0.100





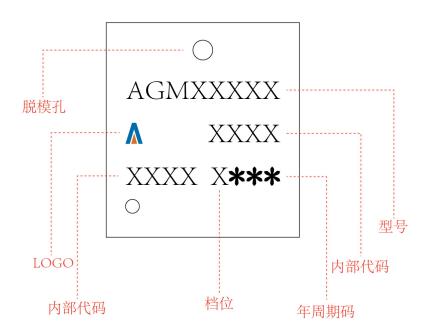
M	
A	-
C	-
D	

		Millimeters	
Symbol	MIN.	NOM.	MAX.
A	0.90	1.05	1. 20
b	0.35	0.40	0.50
С	0.20	0. 25	0.35
D	4.90	5. 05	5. 20
D1	3. 72	3. 82	3. 92
Е	6.00	6. 15	6.30
E1	5. 60	5. 75	5. 90
E2	3. 47	3. 57	3. 67
е	1. 27 BSC.		
Н	0.48	0.58	0.68
K	1. 17	1. 27	1. 37
L	0.64	0.74	0.84
L1/L2	0.20 REF.		
θ	8°	10°	12°
M	0.08 REF.		
N	0	-	0. 15
0	0.25 REF.		
P	1.28 REF.		

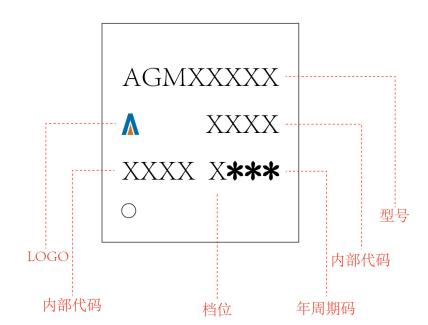


PDFN5*6 Marking Instructions:

Model1:



Model2:





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